

Phison Electronics Corporation PS3111-S11 2.5" SATA SSD (SB260-Small) Specification

Version 1.4



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Revision History

| Revision | Draft Date | History | Author | | | |
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| 1.1 | 2016/02/22 | Update performance, TBW and power consumption. | Elsa Chen | | | |
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| 1.4 2016/05/17 Update product warranty policy. | | | | | | |



Product Overview

- Capacity
 - 64 GB up to 512GB Note3
- SATA Interface
 - SATA Revision 3.2
 - SATA 1.5Gbps, 3Gbps, and 6Gbps interface
- Flash Interface
 - Flash type: MLC
 - 1pcs to 4pcs of TSOP/BGA flash
- Performance
 - Read: up to 560 MB/s
 - Write: up to 465 MB/s
- Power Consumption^{Note1}
 - Active mode: < 1,910 mW
 - Idle mode: < 295 mW
 - DEVSLP mode: < 5 mW
- TBW (Terabytes Written) Note2
 - 544 TBW for 512GB
- Minimum Average Program/Erase Cycles
 - MLC : 3,000 cycles

- MTBF
 - More than 2,000,000 hours
- Advanced Flash Management
 - Static and Dynamic Wear Leveling
 - Bad Block Management
 - TRIM
 - SMART
 - Over-Provision
 - Firmware Update
 - SmartZIPTM
- Low Power Management
 - DEVSLP Mode (Optional)
 - DIPM/HIPM Mode
- Temperature Range
 - Operation: 0°C ~ 70°C
 - Storage: -40°C ~ 85°C
- RoHS compliant

- Notes:
- 1. Please see "4.2 Power Consumption" for details.
- 2. Please see "TBW (Terabytes Written)" in Chapter 2 for details.
- 3. Other capacities can be supported in the future.



Performance and Power Consumption

| | | Performance | | | | Power Consumption | | |
|-----------|-------------------------|-----------------|--------|--------|--------|-------------------|---------|---------|
| Canacity | Flack Churchana | CrystalDiskMark | | ATTO | | Read | Write | DEVSLP |
| Capacity | Flash Structure | Read | Write | Read | Write | (mW) | (mW) | (mW) |
| | | (MB/s) | (MB/s) | (MB/s) | (MB/s) | (11100) | (11100) | (11100) |
| 60/64GB | 16GBx4, TSOP, TSB 15nm | 560 | 335 | 550 | 540 | 1,095 | 1,360 | 4.9 |
| 120/128GB | 32GBx4, TSOP, TSB 15nm | 560 | 465 | 550 | 540 | 1,000 | 1,600 | 4.9 |
| 240/256GB | 64GBx4, TSOP, TSB 15nm | 560 | 465 | 550 | 540 | 1,015 | 1,605 | 4.9 |
| 480/512GB | 128GBx4, TSOP, TSB 15nm | 560 | 465 | 550 | 540 | 1,565 | 1,910 | 4.9 |

NOTE:

For more details on Power Consumption, please refer to Chapter 4.2.



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1. INTRODUCTION

1.1. General Description

Phison's PS3111 2.5" SATA Solid State Disk (SSD) delivers all the advantages of flash disk technology with Serial ATA I/II/III interface, including being fully compliant with standard 2.5-inch form factor, providing low consumption compared traditional hard power to drive and hot-swapping when removing/replacing/upgrading flash disks. The device is designed based on the standard 7-pin interface for data segment and 15-pin for power segment, as well as operating at a maximum operating frequency of 200MHz with 30MHz external crystal. Its capacity could provide a wide range up to 512GB. Moreover, it can reach up to 550MB/s read as well as 500MB/s write high performance based on 16CE and Toggle 2.0 MLC flash (with 32MB SDR enabled and measured by CrystalDiskMark v5.0).

1.2. Controller Block Diagram

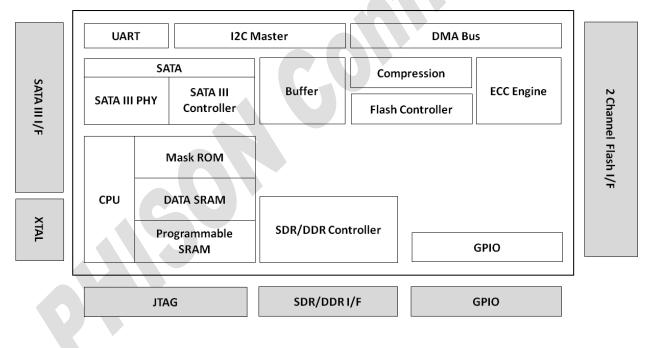


Figure 1-1 PS3111 2.5" SATA SSD Controller Block Diagram

1



1.3. Product Block Diagram

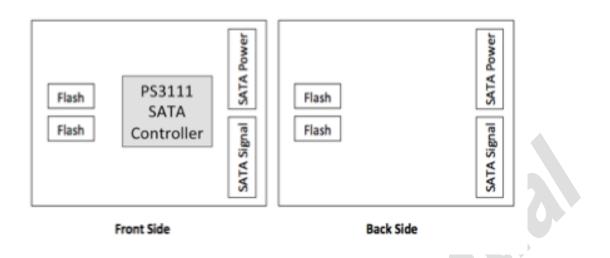


Figure 1-2 PS3111 2.5" SATA SSD Product Block

1.4. Flash Management

1.4.1. Error Correction Code (ECC)

Flash memory cells will deteriorate with use, which might generate random bit errors in the stored data. Thus, PS3111 2.5" SATA SSD applies the LDPC (Low Density Parity Check) of ECC algorithm, which can detect and correct errors occur during read process, ensure data been read correctly, as well as protect data from corruption.

1.4.2. Wear Leveling

NAND flash devices can only undergo a limited number of program/erase cycles, and in most cases, the flash media are not used evenly. If some areas get updated more frequently than others, the lifetime of the device would be reduced significantly. Thus, Wear Leveling is applied to extend the lifespan of NAND flash by evenly distributing write and erase cycles across the media.

Phison provides advanced Wear Leveling algorithm, which can efficiently spread out the flash usage through the whole flash media area. Moreover, by implementing both dynamic and static Wear Leveling algorithms, the life expectancy of the NAND flash is greatly improved.



1.4.3. Bad Block Management

Bad blocks are blocks that include one or more invalid bits, and their reliability is not guaranteed. Blocks that are identified and marked as bad by the manufacturer are referred to as "Initial Bad Blocks". Bad blocks that are developed during the lifespan of the flash are named "Later Bad Blocks". Phison implements an efficient bad block management algorithm to detect the factory-produced bad blocks and manages any bad blocks that appear with use. This practice further prevents data being stored into bad blocks and improves the data reliability.

1.4.4. TRIM

TRIM is a feature which helps improve the read/write performance and speed of solid-state drives (SSD). Unlike hard disk drives (HDD), SSDs are not able to overwrite existing data, so the available space gradually becomes smaller with each use. With the TRIM command, the operating system can inform the SSD which blocks of data are no longer in use and can be removed permanently. Thus, the SSD will perform the erase action, which prevents unused data from occupying blocks all the time.

1.4.5. SMART

SMART, an acronym for Self-Monitoring, Analysis and Reporting Technology, is an open standard that allows a hard disk drive to automatically detect its health and report potential failures. When a failure is recorded by SMART, users can choose to replace the drive to prevent unexpected outage or data loss. Moreover, SMART can inform users of impending failures while there is still time to perform proactive actions, such as copy data to another device.

1.4.6. Over-Provision

Over Provisioning refers to the inclusion of extra NAND capacity in a SSD, which is not visible and cannot be used by users. With Over Provisioning, the performance and IOPS (Input/Output Operations per Second) are improved by providing the controller additional space to manage P/E cycles, which enhances the reliability and endurance as well. Moreover, the write amplification of the SSD becomes lower when the controller writes data to the flash.

1.4.7. Firmware Upgrade

Firmware can be considered as a set of instructions on how the device communicates with the host.



Firmware will be upgraded when new features are added, compatibility issues are fixed, or read/write performance gets improved.

1.5. Low Power Management

1.5.1. DEVSLP Mode (Optional)

With the increasing need of aggressive power/battery life, SATA interfaces include a new feature, Device Sleep (DEVSLP) mode, which helps further reduce the power consumption of the device. DEVSLP enables the device to completely power down the device PHY and other sub-systems, making the device reach a new level of lower power operation. The DEVSLP does not specify the exact power level a device can achieve in the DEVSLP mode, but the power usage can be dropped down to 5mW or less.

1.5.2. DIPM/HIPM Mode

SATA interfaces contain two low power management states for power saving: Partial and Slumber modes. For Partial mode, the device has to resume to full operation within 10 microseconds, whereas the device will spend 10 milliseconds to become fully operational in the Slumber mode. SATA interfaces allow low power modes to be initiated by Host (HIPM, Host Initiated Power Management) or Device (DIPM, Device Initiated Power Management). As for HIPM, Partial or Slumber mode can be invoked directly by the software. For DIPM, the device will send requests to enter Partial or Slumber mode.

1.6. Power Loss Protection: Flushing Mechanism (Optional)

Power Loss Protection is a mechanism to prevent data loss during unexpected power failure. DRAM is a volatile memory and frequently used as temporary cache or buffer between the controller and the NAND flash to improve the SSD performance. However, one major concern of the DRAM is that it is not able to keep data during power failure. Accordingly, the PS3111 applies the *GuaranteedFlush* technology, which requests the controller to transfer data to the cache. For PS3111, SDR performs as a cache, and its size is 32MB. Only when the data is fully committed to the NAND flash will the controller send acknowledgement (ACK) to the host. Such implementation can prevent false-positive performance and the risk of power cycling issues.

Additionally, it is critical for a controller to shorten the time the in-flight data stays in the cache. Thus, Phison's PS3111 applies an algorithm to reduce the amount of data resides in the cache to provide a better



performance. This *SmartCacheFlush* technology allows incoming data to only have a "pit stop" in the cache and then move to the NAND flash at once. If the flash is jammed due to particular file sizes (such as random 4KB data), the cache will be treated as an "organizer", consolidating incoming data into groups before written into the flash to improve write amplification.

In sum, with Flush Mechanism, PS3111 proves to provide the reliability required by consumer, industrial, and enterprise-level applications.

1.7. Advanced Device Security Features

1.7.1. Secure Erase

Secure Erase is a standard ATA command and will write all "0xFF" to fully wipe all the data on hard drives and SSDs. When this command is issued, the SSD controller will erase its storage blocks and return to its factory default settings.

1.7.2. Write Protect

When a SSD contains too many bad blocks and data are continuously written in, then the SSD might not be usable anymore. Thus, Write Protect is a mechanism to prevent data from being written in and protect the accuracy of data that are already stored in the SSD.

1.8. SSD Lifetime Management

1.8.1. Terabytes Written (TBW)

TBW (Terabytes Written) is a measurement of SSDs' expected lifespan, which represents the amount of data written to the device. To calculate the TBW of a SSD, the following equation is applied:

TBW = [(NAND Endurance) x (SSD Capacity) x (WLE)] / WAF

NAND Endurance: NAND endurance refers to the P/E (Program/Erase) cycle of a NAND flash.

<u>SSD Capacity</u>: The SSD capacity is the specific capacity in total of a SSD.

- <u>WLE</u>: Wear Leveling Efficiency (WLE) represents the ratio of the average amount of erases on all the blocks to the erases on any block at maximum.
- <u>WAF</u>: Write Amplification Factor (WAF) is a numerical value representing the ratio between the amount of data that a SSD controller needs to write and the amount of data that the host's flash controller writes. A better WAF, which is near 1, guarantees better endurance and lower frequency of data



written to flash memory.

1.8.2. Thermal Monitor (Optional)

Thermal monitors are devices for measuring temperature, and can be found in SSDs in order to issue warnings when SSDs go beyond a certain temperature. The higher temperature the thermal monitor detects, the more power the SSD consumes, causing the SSD to get aging quickly. Hence, the processing speed of a SSD should be under control to prevent temperature from exceeding a certain range. Meanwhile, the SSD can achieve power savings.

1.9. An Adaptive Approach to Performance Tuning

1.9.1. Throughput

Based on the available space of the disk, PS3111 will regulate the read/write speed and manage the performance of throughput. When there still remains a lot of space, the firmware will continuously perform read/write action. There is still no need to implement garbage collection to allocate and release memory, which will accelerate the read/write processing to improve the performance. Contrarily, when the space is going to be used up, PS3111 will slow down the read/write processing, and implement garbage collection to release memory. Hence, read/write performance will become slower.

1.9.2. Predict & Fetch

Normally, when the host tries to read data from the SSD, the SSD will only perform one read action after receiving one command. However, PS3111 applies *Predict & Fetch* to improve the read speed. When the host issues sequential read commands to the SSD, the SSD will automatically expect that the following will also be read commands. Thus, before receiving the next command, flash has already prepared the data. Accordingly, this accelerates the data processing time, and the host does not need to wait so long to receive data.

1.9.3. SmartZIP[™]

Write data to the NAND Flash costs time. To improve the write speed performance, PS3111 launches with compression technique—SmartZIP[™]

Whether a file could be compressed or not depending on the file type, for file types have redundancy data



pattern, through our embedded encode engine, we could reduce the amount of data that is actually written to the Flash. Comparing to the SSD without the compression, write efficiency is raised and the SSD endurance is also improved since Flash could be benefit from less data written for a longer SSD lifetime.



2. PRODUCT SPECIFICATIONS

Capacity

- From 64GB up to 512GB (support 48-bit addressing mode)
- Electrical/Physical Interface
 - SATA Interface
 - Compliant with SATA Revision 3.2
 - Compatible with SATA 1.5Gbps, 3Gbps and 6Gbps interface
 - Support power management
 - Support expanded register for SATA protocol 48 bits addressing mode
 - Embedded BIST function for SATA PHY for low cost mass production
- Built-in 2-channel NAND flash interface controller
 - Compliant with Toggle 1.0 and Toggle 2.0 NAND Flash interface
 - Compliant with ONFI 4.0 interface:
 - SDR up to mode 5
 - NV-DDR up to mode 5
 - NV-DDR2 up to mode 7
 - NV-DDR3 up to mode 8
- Supported NAND Flash
 - Support up to 16 Flash Chip Enables (CE) within single design
 - Toshiba 24nm SLC; 15nm/3D-NAND MLC; 15nm/3D-NAND TLC
 - Intel/Micron 16nm/3D-NAND MLC and TLC
 - Hynix 16nm/3D-NAND
 - Support all types of SLC/MLC/TLC/3D-NAND, 8KB/page and 16K/page NAND flash
 - Support ONFI 2.3, ONFI 3.0, ONFI 3.2 and ONFI 4.0 interface: 2 channels at maximum
 - Support 8-bit I/O NAND Flash
 - Contain 1pcs to 4pcs of TSOP/BGA flash
- ECC Scheme
 - PS3111 2.5"SSD applies the LDPC (Low Density Parity Check) of ECC algorithm.
- UART function
- GPIO
- Support SMART and TRIM commands



Performance

| | Flash | | Sequential | | |
|-----------|-----------|----------------|------------|--------|--|
| Capacity | Structure | Flash Type | Read | Write | |
| | | | (MB/s) | (MB/s) | |
| 60/64GB | 16GB x 4 | TSOP, TSB 15nm | 560 | 335 | |
| 120/128GB | 32GB x 4 | TSOP, TSB 15nm | 560 | 465 | |
| 240/256GB | 64GB x 4 | TSOP, TSB 15nm | 560 | 465 | |
| 480/512GB | 128GB x 4 | TSOP, TSB 15nm | 560 | 465 | |

NOTES:

- 1. The performance was measured using CrystalDiskMarkv5.0x64 with SATA 6Gbps host.
- 2. Samples were built using Toshiba 15nm Toggle MLC NAND.
- 3. Performance may differ according to flash configuration and platform.
- 4. The table above is for reference only. The criteria for MP (mass production) and for accepting goods shall be discussed based on different flash configuration.

• TBW (Terabytes Written)

| Capacity | Flash Structure | TBW |
|-----------|-----------------|-----|
| 60/64GB | 16GB x 4 | 90 |
| 120/128GB | 32GB x 4 | 181 |
| 240/256GB | 64GB x 4 | 262 |
| 480/512GB | 128GB x 4 | 544 |

NOTES:

- 1. Samples were built using Toshiba 15nm Toggle MLC NAND.
- 2. The test followed JEDEC219A client endurance workload.
- 3. TBW may differ according to flash configuration and platform.

4. The endurance of SSD could be estimated based on user behavior, NAND endurance cycles, and write amplification factor. It is not guaranteed by flash vendor.



3. ENVIRONMENTAL SPECIFICATIONS

3.1. Environmental Conditions

3.1.1. Temperature and Humidity

- Temperature:
 - Storage: -40°C to 85°C
 - ♦ Operational: 0°C to 70°C
- Humidity: RH 90% under 40°C (operational)

Table 3-1 High Temperature Test Condition

| | Temperature | Humidity | Test Time |
|-----------|-------------|----------|-----------|
| Operation | 70°C | 0% RH | 72 hours |
| Storage | 85°C | 0% RH | 72 hours |

Result: No any abnormality is detected.

Table 3-2 Low Temperature Test Condition

| | Temperature | Humidity | Test Time |
|-----------|-------------|----------|-----------|
| Operation | 0°C | 0% RH | 72 hours |
| Storage | -40°C | 0% RH | 72 hours |

Result: No any abnormality is detected.

Table 3-3 High Humidity Test Condition

| | Temperature | Humidity | Test Time |
|-----------|-------------|----------|-----------|
| Operation | 40°C | 90% RH | 4 hours |
| Storage | 40°C | 93% RH | 72 hours |

Result: No any abnormality is detected.

Table 3-4 Temperature Cycle Test

| | Temperature | Test Time | Cycle |
|-----------|-------------|-----------|-----------|
| Oneration | 0°C | 30 min | 10 Cuolos |
| Operation | 70°C | 30 min | 10 Cycles |
| Storage | -40°C | 30 min | 10 Cuolos |
| | 85°C | 30 min | 10 Cycles |

Result: No any abnormality is detected.



3.1.2. Shock

Table 3-5 PS3111 2.5" SATA SSD Shock Specification

| | Acceleration Force | Half Sin Pulse Duration |
|-----------------|--------------------|-------------------------|
| Non-operational | 1500G | 0.5ms |

Result: No any abnormality is detected when power on.

3.1.3. Vibration

Table 3-6 PS3111 2.5" SATA SSD Vibration Specification

| | Cond | Vibration Orientation | |
|-----------------|---|-----------------------|------------------------------|
| | Frequency/Displacement Frequency/Acceleration | | vibration Orientation |
| Non-operational | 20Hz~80Hz/1.52mm | 80Hz~2000Hz/20G | X, Y, Z axis/60 min for each |

Result: No any abnormality is detected when power on.

3.1.4. Drop

Table 3-7 PS3111 2.5" SATA SSD Drop Specification

| | Height of Drop | Number of Drop |
|-----------------|----------------|---------------------|
| Non-operational | 80cm free fall | 6 face of each unit |
| | | |

Result: No any abnormality is detected when power on.

3.1.5. Bending

Table 3-8 PS3111 2.5" SATA SSD Bending Specification

| | Force | Action |
|-----------------|-------|------------------|
| Non-operational | ≥ 50N | Hold 1min/5times |

Result: No any abnormality is detected when power on.

3.1.6. Torque

Table 3-9 PS3111 2.5" SATA SSD Torque Specification

| | Force | Action | |
|-----------------|---------------------|------------------|--|
| Non-operational | 1.263N-m or ±10 deg | Hold 1min/5times | |

Result: No any abnormality is detected when power on.



3.1.7. Electrostatic Discharge (ESD)

Table 3-10 PS3111 2.5" SATA SSD Contact ESD Specification

| Device | Capacity | Temperature | Relative Humidity | +/- 4KV | Result |
|----------|----------|-------------|-------------------|------------------------------------|--------|
| | 256GB | | | Device functions are affected, but | |
| 2.5" SSD | | 24.0°C | 49% (RH) | EUT will be back to its normal or | PASS |
| | 512GB | | | operational state automatically. | |

3.1.8. EMI Compliance

- FCC: CISPR22
- CE: EN55022
- BSMI 13438

3.2. MTBF

MTBF, an acronym for Mean Time Between Failures, is a measure of a device's reliability. Its value represents the average time between a repair and the next failure. The measure is typically in units of hours. The higher the MTBF value, the higher the reliability of the device. The predicted result of Phison's PS3111 2.5" SATA SSD is more than 2,000,000 hours.

3.3. Certification & Compliance

- RoHS
- SATA III (SATA Rev. 3.2)
- Up to ATA/ATAPI-8 (Including S.M.A.R.T)



4. ELECTRICAL SPECIFICATIONS



Table 4-1 Supply Voltage of PS3111 2.5" SATA SSD

| Parameter | Rating | | | |
|-------------------|--------|--|--|--|
| Operating Voltage | 5V | | | |

4.2. Power Consumption

Table 4-2 Power Consumption of PS3111 2.5" SATA SSD

| Capacity | Flash | Floch Type | Read | Write | Partial | Slumber | Idle | DEVSLP |
|-----------|-----------|----------------|-------|-------|---------|---------|------|--------|
| | Structure | Flash Type | (mW) | (mW) | (mW) | (mW) | (mW) | (mW) |
| 60/64GB | 16GB x 4 | TSOP, TSB 15nm | 1,095 | 1,360 | 17 | 11 | 287 | 4.9 |
| 120/128GB | 32GB x 4 | TSOP, TSB 15nm | 1,000 | 1,600 | 18 | 12.5 | 285 | 4.9 |
| 240/256GB | 64GB x 4 | TSOP, TSB 15nm | 1,015 | 1,605 | 18 | 12.5 | 285 | 4.9 |
| 480/512GB | 128GB x4 | TSOP, TSB 15nm | 1,565 | 1,910 | 19 | 13.5 | 295 | 4.9 |

NOTES:

1. The average value of power consumption is achieved based on 100% conversion efficiency.

- 2. The measured power voltage is 5V.
- Samples were built using Toshiba 15nm Toggle MLC NAND.
 It's measured under ambient temperature.
- 4. Sequential R/W is measured while testing 4000MB sequential R/W 5 times by CyrstalDiskMark. DEVSLP is measured while entering device sleep mode for 5 minutes.
- 5. Power Consumption may differ according to flash configuration and platform.



5. INTERFACE

5.1. Pin Assignment and Descriptions

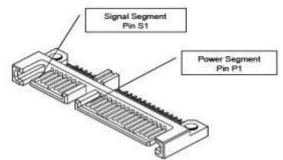


Figure 5-1 PS3111 2.5" SATA SSD Pin Assignment

Table 5-1 Signal Segment Pin Assignment and Descriptions

| Pin Number | Function | | | |
|------------|----------------------------------|--|--|--|
| S1 | GND | | | |
| S2 | A+ (Differential Signal Pair A) | | | |
| \$3 | A – (Differential Signal Pair A) | | | |
| S4 | GND | | | |
| S5 | B – (Differential Signal Pair B) | | | |
| S6 | B+ (Differential Signal Pair B) | | | |
| S7 | GND | | | |

Table 5-2 Power Segment Pin Assignment and Descriptions

| Pin Number | Function |
|------------|---------------------------|
| P1 | Not Used (3.3V) |
| P2 | Not Used (3.3V) |
| Р3 | DEVSLP |
| P4 | GND |
| Р5 | GND |
| P6 | GND |
| P7 | 5V pre-charge |
| P8 | 5V |
| Р9 | 5V |
| P10 | GND |
| P11 | Reserved |
| P12 | GND |
| P13 | Not Used (12V pre-charge) |
| P14 | Not Used (12V) |
| P15 | Not Used (12V) |



6. SUPPORTED COMMANDS

6.1. ATA Command List

The following ATA command list table is followed by ATA8-ACS4 SPEC.

| Op Code | Description | 0 | p Coc | le | Description |
|---------|-----------------------------------|-----|-------|-----|--|
| 00h | NOP | C9h | | | Read DMA without Retry |
| 06h | Data Set Management | CAh | | | Write DMA |
| 10h-1Fh | Recalibrate | | CBh | | Write DMA without Retry |
| 20h | Read Sectors | | CEh | | Write Multiple FUA EXT |
| 21h | Read Sectors without Retry | | E0h | | Standby Immediate |
| 24h | Read Sectors EXT | | E1h | | Idle Immediate |
| 25h | Read DMA EXT | | E2h | | Standby |
| 27h | Read Native Max Address EXT | | E3h | | Idle |
| 29h | Read Multiple EXT | | E4h | | Read Buffer |
| 2Fh | Read Log EXT | | E5h | | Check Power Mode |
| 30h | Write Sectors | | E6h | | Sleep |
| 31h | Write Sectors without Retry | | E7h | | Flush Cache |
| 34h | Write Sectors EXT | | E8h | | Write Buffer |
| 35h | Write DMA EXT | E9h | | | READ BUFFER DMA |
| 37h | Set Native Max Address EXT | EAh | | | Flush Cache EXT |
| 38h | CFA Write Sectors Without Erase | EBh | | | Write Buffer DMA |
| 39h | Write Multiple EXT | | ECh | | Identify Device |
| 3Dh | Write DMA FUA EXT | | EFh | | Set Features |
| 3Fh | Write Long EXT | EFh | 02 | 2h | Enable volatile write cache |
| 40h | Read Verify Sectors | EFh | 03 | 3h | Set transfer mode |
| 41h | Read Verify Sectors without Retry | EFh | 05 | ōh | Enable the APM feature set |
| 42h | Read Verify Sectors EXT | EFh | 10 | Dh | Enable use of SATA features et |
| 44h | Zero EXT | EFh | 10h | 02h | Enable DMA Setup FIS Auto-Activate optimization |
| 45h | Write Uncorrectable EXT | EFh | 10h | 03h | Enable Device-initiated interface power state (DIPM) transitions |
| 47h | Read Log DMA EXT | EFh | 10h | 06h | Enable Software Settings Preservation (SSP) |
| 57h | Write Log DMA EXT | EFh | 10h | 07h | Enable Device Automatic Partial to Slumber transitions |
| 60h | Read FPDMA Queued | EFh | 10h | 09h | Enable Device Sleep |
| 61h | Write FPDMA Queued | EFh | 55 | 5h | Disable read look-ahead |
| 70h-7Fh | Seek | EFh | 66 | ōh | Disable reverting to power-on defaults |





| Ор | Code | Description | Op Code | | le | Description |
|-----|------|---|---------|---------|------|---|
| 9 | 0h | Execute Device Diagnostic | EFh | 82 | 2h | Disable volatile write cache |
| 9 | 1h | Initialize Device Parameters | EFh | 85 | ōh | Disable the APM feature set |
| 9 | 2h | Download Microcode | EFh | 90 | Dh | Disable use of SATA feature set |
| 9 | 3h | Download Microcode DMA | EFh | 90h | 02h | Disable DMA Setup FIS Auto-Activate optimization |
| В | 0h | SMART | EFh | 90h | 03h | Disable Device-initiated interface power state (DIPM) transitions |
| B0h | D0h | SMART READ DATA | EFh | 90h 06h | | Disable Software Settings Preservatior (SSP) |
| B0h | D1h | SMART READ ATTRIBUTE THRESHOLDS | EFh | 90h | 07h | Disable Device Automatic Partial to Slumber transitions |
| B0h | D2h | SMART ENABLE/DISABILE ATTRIBUTE AUTOSAVE | EFh | 90h | 09h | Disable Device Sleep |
| B0h | D3h | SMART SAVE ATTRIBUTE VALUES | EFh | A | ۹h | Enable read look-ahead |
| B0h | D4h | SMART EXECUTE OFF-LINE IMMEDIATE | EFh | C | Ch | Enable reverting to power-on defaults |
| B0h | D5h | SMART READ LOG | | F1h | | Security Set Password |
| B0h | D6h | SMART WRITE LOG | | F2h | | Security Unlock |
| B0h | D8h | SMART ENABLE OPERATIONS | | F3h | | Security Erase Prepare |
| B0h | D9h | SMART DISABLE OPERATIONS | | F4h | | Security Erase Unit |
| B0h | DAh | SMART RETURN STATUS | | F5h | | Security Freeze Lock |
| B0h | DBh | SMART ENABLE/DISABILE AUTOMATIC OFF-LINE | | F6h | | Security Disable Password |
| В | 1h | Device Configuration | F8h | | | Read Native Max Address |
| В | 4h | Sanitize | | F9h | | Set Max Address |
| С | 4h | Read Multiple | F9h | 01 | lh | SET MAX SET PASSWORD |
| С | 5h | Write Multiple | F9h | 02 | 2h | SET MAXLOCK |
| С | 6h | Set Multiple Mode | F9h | 03 | ßh | SET MAX UNLOCK |
| ~ | 8h | Read DMA | F9h | 04 | lh - | SET MAX FREEZE LOCIK |



6.2. Identify Device Data

The following table details the sector data returned by the IDENTIFY DEVICE command of ATA8-ACS4 SPEC.

| Word | F: Fixed V: Variable X: retired/obsolete /reserved | Default Value | Description |
|-------|--|---------------|---|
| 0 | F | 0040h | General configuration bit-significant information |
| 1 | Х | *1 | Obsolete |
| 2 | F | C837h | Specific configuration |
| 3 | Х | 0010h | Obsolete |
| 4-5 | Х | 00000000h | Retired |
| 6 | Х | 003Fh | Obsolete |
| 7-8 | Х | 00000000h | Reserved for assignment by the Compact Flash Association |
| 9 | х | 0000h | Retired |
| 10-19 | V | Varies | Serial number (20 ASCII characters) |
| 20-21 | х | 00000000h | Retired |
| 22 | х | 0000h | Obsolete |
| 23-26 | V | Varies | Firmware revision (8 ASCII characters) |
| 27-46 | V | Varies | Model number (xxxxxxx) |
| 47 | F | 8010h | 7:0- Maximum number of sectors transferred per interrupt on MULTIPLE commands |
| 48 | F | 4000h | Trusted Computing feature set options(not support) |
| 49 | F | 2F00h | Capabilities |
| 50 | F | 4000h | Capabilities |
| 51-52 | x | 000000000h | Obsolete |
| 53 | F | 0007h | Words 88 and 70:64 valid |
| 54 | x | *1 | Obsolete |
| 55 | x | 0010h | Obsolete |
| 56 | Х | 003Fh | Obsolete |
| 57-58 | х | *2 | Obsolete |
| 59 | F | 5D10h | Sanitize and Number of sectors transferred per |
| | | | interrupt on MULTIPLE commands |
| 60-61 | V | *3 | Maximum number of sector (28bit LBA mode) |
| 62 | х | 0000h | Obsolete |

Table 6-2 List of Device Identification



| Word | F: Fixed V: Variable X: retired/obsolete /reserved | Default Value | Description |
|-------|--|---|---|
| 63 | F | 0407h | Multi-word DMA modes supported/selected |
| 64 | F | 0003h | PIO modes supported |
| 65 | F | 0078h | Minimum Multiword DMA transfer cycle time per word |
| 66 | F | 0078h | Manufacturer's recommended Multiword DMA transfer cycle time |
| 67 | F | 0078h | Minimum PIO transfer cycle time without flow control |
| 68 | F | 0078h | Minimum PIO transfer cycle time with IORDY flow control |
| 69 | F | 1F00h | Additional Supported (support download microcode DMA) |
| 70 | x | 0000h | Reserved |
| 71-74 | Х | 000000000000000000000000000000000000000 | Reserved for the IDENTIFY PACKET DEVICE command |
| | | 0000h | |
| 75 | F | 001Fh | Queue depth |
| 76 | F | 850Eh | Serial SATA capabilities |
| 77 | F | 0006h | Serial ATA Additional Capabilities |
| 78 | F | 004Ch | Serial ATA features supported |
| 79 | F | 0040h | Serial ATA features enabled |
| 80 | F | 0FF8h | Major Version Number |
| 81 | F | 0000h | Minor Version Number |
| 82 | F | 746Bh | Command set supported |
| 83 | F | 7D01h | Command set supported |
| 84 | F | 4163h | Command set/feature supported extension |
| 85 | F | 7469h | Command set/feature enabled |
| 86 | F | BC01h | Command set/feature enabled |
| 87 | F | 4163h | Command set/feature default |
| 88 | F | 007Fh | Ultra DMA Modes |
| 89 | F | 0003h | Time required for security erase unit completion |
| 90 | F | 001Eh | Time required for Enhanced security erase completion |
| 91 | F | 0000h | Current advanced power management value |
| 92 | F | FFFEh | Master Password Revision Code |
| 93 | F | 0000h | Hardware reset result. For SATA devices, word 93 shall be set to the value 0000h. |



| Word | F: Fixed V: Variable X: retired/obsolete /reserved | Default Value | Description |
|---------|--|---------------------------|--|
| 94 | Х | 0000h | Obsolete |
| 95 | F | 0000h | Stream Minimum Request Size |
| 96 | F | 0000h | Streaming Transfer Time – DMA |
| 97 | F | 0000h | Streaming Access Latency – DMA and PIO |
| 98-99 | F | 00000000h | Streaming Performance Granularity |
| 100-103 | V | *4 | Maximum user LBA for 48 bit Address feature set |
| 104 | F | 0000h | Streaming Transfer Time – PIO |
| 105 | F | 0008h | Maximum number of 512-byte blocks per DATA SET MANAGEMENT command |
| 106 | F | 4000h | Physical sector size/Logical sector size |
| 107 | F | 0000h | Inter-seek delay for ISO-7779 acoustic testing in microseconds |
| 108-111 | V | Varies | World Wide Name |
| 112-115 | х | 000000000000 0000h | Reserved |
| 116 | Х | 0000h | Reserved |
| 117-118 | F | 00000000h | Words per logical Sector |
| 119 | F | 401Ch | Supported settings |
| 120 | F | 401Ch | Command set/Feature Enabled/Supported |
| 121-126 | х | 0h | Reserved |
| 127 | х | 0000h | Obsolete |
| 128 | F | 0021h | Security status |
| 129-140 | V | Varies | Vendor specific |
| 141 | v | Varies | Vendor specific |
| 142-159 | V | Varies | Vendor specific |
| 160 | x | 0000h | Reserved for CFA |
| 161-167 | x | 0h | Reserved for CFA |
| 168 | V | Varies | Device Nominal Form Factor |
| 169 | F | 0001h | DATA SET MANAGEMENT command is supported |
| 170-173 | F | 000000000000 000 0h | Additional Product Identifier |
| 174-175 | х | 00000000h | Reserved |
| 176-205 | F | 0h | Current media serial number |



| Word | F: Fixed V: Variable X: retired/obsolete /reserved | Default Value | Description |
|---------|--|-------------------------|---|
| 206 | F | 0000h | SCT Command Transport |
| 207-208 | Х | 00000000h | Reserved |
| 209 | F | 4000h | Alignment of logical blocks within a physical block |
| 210-211 | F | 00000000h | Write-Read-Verify Sector Count Mode 3 (not support) |
| 212-213 | F | 00000000h | Write-Read-Verify Sector Count Mode 2 (not support) |
| 214-216 | Х | 0h | Obsolete |
| 217 | F | 0001h | Non-rotating media device |
| 218 | х | 0000h | Reserved |
| 219 | х | 0000h | NV Cache relate (not support) |
| 220 | V | 0000h | Write read verify feature set current mode |
| 221 | Х | 0000h | Reserved |
| 222 | F | 10FFh | Transport major version number |
| 223 | F | 0000h | Transport minor version number |
| 224-229 | х | 0h | Reserved |
| 230-233 | F | 000000000000 0000h | Extend number of user addressable sectors |
| 234 | F | 0001h | Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h |
| 235 | F | FFFEh | Maximum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h |
| 236-254 | Х | 0h | Reserved |
| 255 | F | XXA5h XX is variable | Integrity word (Checksum and Signature) |

Table 6-3 List of Device Identification for Each Capacity

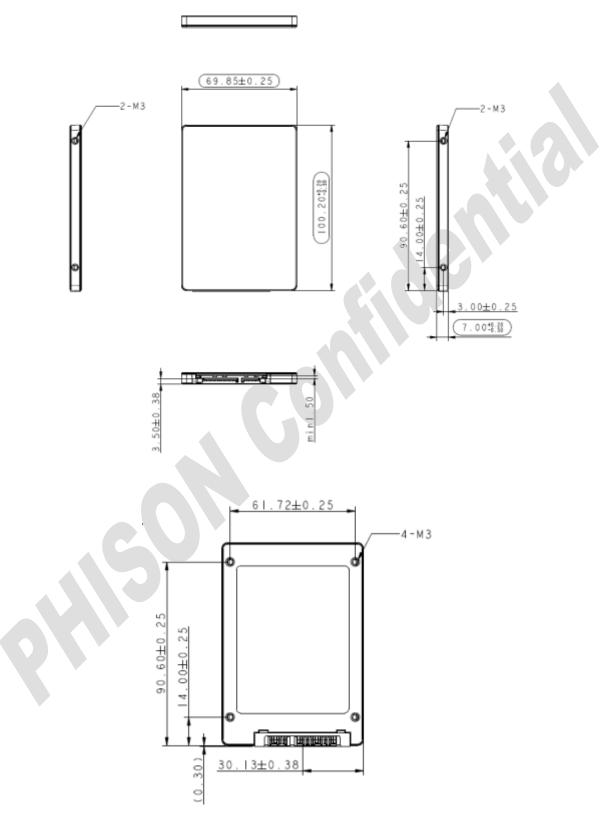
| Capacity | *1 | *2 | *3 | *4 |
|----------|------------------|----------------|----------------|------------------|
| (GB) | (Word 1/Word 54) | (Word 57 – 58) | (Word 60 – 61) | (Word 100 – 103) |
| 8 | 3CA5h | EEC9B0h | EEC9B0h | EEC9B0h |
| 16 | 3FFFh | FBFC10h | 1DD40B0h | 1DD40B0h |
| 32 | 3FFFh | FBFC10h | 3BA2EB0h | 3BA2EB0h |
| 60 | 3FFFh | FBFC10h | 6FCCF30h | 6FCCF30h |
| 64 | 3FFFh | FBFC10h | 7740AB0h | 7740AB0h |
| 120 | 3FFFh | FBFC10h | DF94BB0h | DF94BB0h |
| 128 | 3FFFh | FBFC10h | EE7C2B0h | EE7C2B0h |





7. PHYSICAL DIMENSION

Dimension: 100mm (L) x 69.85mm (W) x 7.00mm (H)





8. PRODUCT WARRANTY POLICY

Warranty period of the Product is twelve (12) months from the date of manufacturing. In the event the Product does not conform to the specification within the aforementioned twelve (12)-month period and such non conformity is solely attributable to Phison's cause, Phison agrees at its discretion replace or repair the nonconforming Product. Notwithstanding the foregoing, the aforementioned warranty shall exclude the nonconformity arising from, in relation to or associated with:

(1) alternation, modification, improper use, misuse or excessive use of the Product;

(2) failure to comply with Phison's instructions;

(3) Phison's compliance with customer or user indicated instructions, technologies, designs, specifications, materials, components, parts;

(4) combination of the Product with other materials, components, parts, goods, hardware, firmware or software designated or provided by customer; or

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(6) other error or failure not solely attributable to Phison's cause (including without limitation, normal wear or tear, manufacturing or assembly wastage, improper operation, virus, unauthorized maintenance or repair).

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9. REFERENCE

The following table is to list out the standards that have been adopted for designing the product.

| Title | Acronym/Source | | |
|---|---|--|--|
| RoHS | Restriction of Hazardous Substances Directive; for further information, | | |
| копз | please contact us at <u>sales@phison.com</u> or <u>support@phison.com</u> . | | |
| Serial ATA Revision 3.2 <u>http://www.sata-io.org</u> | | | |
| ATA-8 spec | http://www.t13.org | | |
| FCC: CISPR22 | Federal Communications Commission; for further information, please | | |
| FCC: CISPR22 | contact us at <u>sales@phison.com</u> or <u>support@phison.com</u> . | | |
| | Consumer electronics certification; for further information, please | | |
| CE: EN55022 | contact us at <u>sales@phison.com</u> or <u>support@phison.com</u> . | | |
| | The Bureau of Standards, Metrology and Inspection; for further | | |
| BSMI: 13438 | information, please contact us at <u>sales@phison.com</u> or | | |
| | support@phison.com. | | |

Table 9-1 List of References



10. TERMINOLOGY

The following table is to list out the acronyms that have been applied throughout the document.

| Term | Definitions |
|------------|--|
| ATTO | Commercial performance benchmark application |
| DEVSLP | Device sleep mode |
| DIPM | Device initiated power management |
| HIPM | Host initiated power management |
| LBA | Logical block addressing |
| MB | Mega-byte |
| MTBF | Mean time between failures |
| NCQ | Native command queue |
| SATA | Serial advanced technology attachment |
| SDR | Synchronous dynamic access memory |
| S.M.A.R.T. | Self-monitoring, analysis and reporting technology |
| SSD | Solid state disk |

Table 10-1 List of Terminology